TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MA2244FK

Low-Voltage Octal Bus Buffer with 3.6 V Tolerant Inputs and Outputs

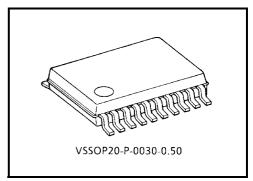
The TC7MA2244FK is a high performance CMOS octal bus buffer. Designed for use in 1.8 V, 2.5 V or 3.3 V systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

It is also designed with over voltage tolerant inputs and outputs up to 3.6 V.

This device is non-inverting 3-state buffer having four active-low output enables. When the \overline{ST} input is high, the outputs are in a high impedance state. This device is designed to be used with 3-state memory address drivers, etc.

The 26 Ω series resistor helps reducing output overshoot and undershoot without external resistor.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.03 g (typ.)

Features

- 26Ω series resistors on outputs.
- Low voltage operation: $V_{CC} = 1.8 \sim 3.6 \text{ V}$
- High speed operation: $t_{pd} = 4.4 \text{ ns (max)} (V_{CC} = 3.0 \sim 3.6 \text{ V})$

 $t_{pd} = 5.6 \text{ ns (max) (VCC} = 2.3 \sim 2.7 \text{ V)}$

 $t_{pd} = 9.8 \text{ ns (max) (VCC} = 1.8 \text{ V)}$

- 3.6 V tolerant inputs and outputs.
- Output current: $IOH/IOL = \pm 12 \text{ mA (min)} (VCC = 3.0 \text{ V})$

 $IOH/IOL = \pm 8 \text{ mA (min) (VCC} = 2.3 \text{ V)}$

 $I_{OH}/I_{OL} = \pm 4 \text{ mA (min) (V}_{CC} = 1.8 \text{ V)}$

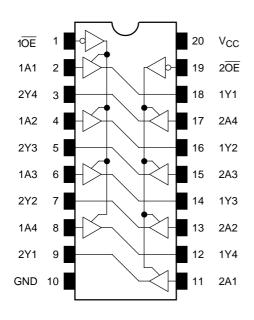
- Latch-up performance: ±300 mA
- ESD performance: Machine model > ±200 V

Human body model $> \pm 2000 \text{ V}$

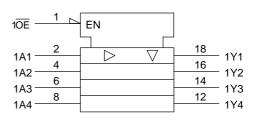
- Package: VSSOP (US20)
- Power down protection is provided on all inputs and outputs.
- Supports live insertion/withdrawal (*)

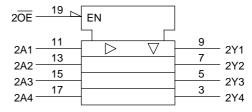
^{*:} To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

Pin Assignment (top view)



IEC Logic Level





Truth Table

Inp	Outputs	
ŌĒ	An	Outputs
L	L	L
L	Н	Н
Н	Х	Z

X: Don't care

Z: High impedance

Maximum Ratings

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5~4.6	V
DC input voltage	V _{IN}	-0.5~4.6	V
DC output voltage	V	-0.5~4.6 (Note1)	V
DC output voltage	Vout	-0.5~V _{CC} + 0.5 (Note2)	V
Input diode current	I _{IK}	-50	mA
Output diode current	lok	±50 (Note3)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65~150	°C

Note1: Off-state

Note2: High or low state. IOUT absolute maximum rating must be observed.

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Note3: $V_{OUT} < GND, V_{OUT} > V_{CC}$



Recommended Operating Range

Characteristics	Symbol	Rating	Unit
Supply voltage	V	1.8~3.6	V
Supply voltage	V _{CC}	1.2~3.6 (Note4)	V
Input voltage	V _{IN}	-0.3~3.6	V
Output voltage	\/ -	0~3.6 (Note5)	V
Output voltage	Vout	0~V _{CC} (Note6)	V
		±12 (Note7)	
Output current	I _{OH} /I _{OL}	±8 (Note8)	mA
		±4 (Note9)	
Operating temperature	T _{opr}	-40~85	°C
Input rise and fall time	dt/dv	0~10 (Note10)	ns/V

Note4: Data retention only

Note5: Off-state

Note6: High or low state

Note7: $V_{CC} = 3.0 \sim 3.6 \text{ V}$

Note8: $V_{CC} = 2.3 \sim 2.7 \text{ V}$

Note9: $V_{CC} = 1.8 \text{ V}$

Note10: $V_{IN} = 0.8 \sim 2.0 \text{ V}, V_{CC} = 3.0 \text{ V}$

Electrical Characteristics

DC Characteristics (Ta = -40~85°C, 2.7 V < V_{CC} \leq 3.6 V)

Characteristics		Symbol	Test Condition			Min	Max	Unit
Characte	HSUCS	Symbol	rest condition		V _{CC} (V)	IVIII	IVIAX	Unit
Input voltage	High level	V_{IH}		_	2.7~3.6	2.0	_	V
iliput voltage	Low level	V _{IL}		_	2.7~3.6	_	0.8	v
				$I_{OH} = -100 \mu A$	2.7~3.6	V _{CC} - 0.2	_	
	High level	Voh	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -6 \text{ mA}$	2.7	2.2	_	
				$I_{OH} = -8 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -12 \text{ mA}$	3.0	2.2	_	V
			$I_{OL} = 100 \mu A$	2.7~3.6	_	0.2		
	Low level	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OL} = 6 mA	2.7	_	0.4	
	Low level			I _{OL} = 8 mA	3.0	_	0.55	
				I _{OL} = 12 mA	3.0	_	0.8	
Input leakage curr	ent	I _{IN}	V _{IN} = 0~3.6 V		2.7~3.6	_	±5.0	μА
2 state output off o	otata aurrant	la-	$V_{IN} = V_{IH}$ or V_{IL}		2.7~3.6	_	±10.0	
3-state output off-state current		loz	V _{OUT} = 0~3.6 V		2.7~3.0		±10.0	μΑ
Power off leakage	current	l _{OFF}	V _{IN} , V _{OUT} = 0~3.6 V		0	_	10.0	μА
		laa	V _{IN} = V _{CC} or GND		2.7~3.6	_	20.0	
Quiescent supply	current	Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6 \text{ V}$		2.7~3.6	_	±20.0	μΑ
		Δl _{CC}	$V_{IH} = V_{CC} - 0.6 V$ (pe	er input)	2.7~3.6	_	750	

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DC Characteristics (Ta = $-40~85^{\circ}$ C, 2.3 V \leq V_{CC} \leq 2.7 V)

Characteri	stics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit			
Input voltage	High level	V _{IH}		_	2.3~2.7	1.6	_	V			
input voltage	Low level	V _{IL}		_	2.3~2.7	_	0.7	٧			
				I _{OH} = -100 μA	2.3~2.7	V _{CC} - 0.2					
	High level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -4 \text{ mA}$	2.3	2.0	_				
				$I_{OH} = -6 \text{ mA}$	2.3	1.8	_				
Output voltage				$I_{OH} = -8 \text{ mA}$	2.3	1.7	_	V			
			$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100 \mu A$	2.3~2.7	_	0.2				
	Low level	V _{OL}		$V_{IN} = V_{IH}$ or V_{IL}	$V_{IN} = V_{IH}$ or V_{IL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 6 \text{ mA}$	2.3	_	0.4	
				$I_{OL} = 8 \text{ mA}$	2.3	_	0.6				
Input leakage curre	nt	I _{IN}	V _{IN} = 0~3.6 V		2.3~2.7	_	±5.0	μΑ			
3-state output off-st	3-state output off-state current		$V_{IN} = V_{IH}$ or V_{IL}		2.3~2.7		±10.0	μА			
o state output on state outront		loz	V _{OUT} = 0~3.6 V		2.0 2.7		±10.0	μιτ			
Power off leakage	current	I _{OFF}	$V_{IN}, V_{OUT} = 0 \sim 3.6 \text{ V}$		0	_	10.0	μА			
Quiescent supply c	urrent	Icc	$V_{IN} = V_{CC}$ or GND		2.3~2.7	_	20.0	μА			
Quissourit supply o	anoni.	100	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3$	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6 \text{ V}$		_	±20.0	μιτ			

DC Characteristics (Ta = $-40 \sim 85$ °C, 1.8 V \leq V_{CC} < 2.3 V)

Characteris	stics	Symbol	Test Condition			Min	Max	Unit
		Í			V _{CC} (V)			
Input voltage	High level	V _{IH}	-	_	1.8~2.3	$^{0.7\times}_{\text{VCC}}$		V
input voltage	Low level	V _{IL}		_	1.8~2.3	_	0.2 × V _{CC}	V
	High level	Voн	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.8	V _{CC} - 0.2	_	
Output voltage				$I_{OH} = -4 \text{ mA}$	1.8	1.4	_	V
	Low level	V	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.8	_	0.2	
	Low level	V _{OL}		I _{OL} = 4 mA	1.8	_	0.3	
Input leakage currer	nt	I _{IN}	V _{IN} = 0~3.6 V	•	1.8	_	±5.0	μΑ
3-state output off-sta	ate current	loz	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \sim 3.6 \text{ V}$		1.8	_	±10.0	μА
Power off leakage c	urrent	I _{OFF}	V _{IN} , V _{OUT} = 0~3.6 V		0	_	10.0	μΑ
Out a cont our plu our set		loo	$V_{IN} = V_{CC}$ or GND		1.8		20.0	μА
Quiescent supply cu	ni Giit	Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6 \text{ V}$		1.8	_	±20.0	μΑ

AC Characteristics (Ta = -40~85°C, Input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF, $R_L = 500 \Omega$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
	4		1.8	1.5	9.8	
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2	0.8	5.6	ns
	^t pHL		3.3 ± 0.3	0.6	4.4	
	.		1.8	1.5	9.8	
3-state output enable	t _{pZL} t _{pZH}	Figure 1, Figure 3	2.5 ± 0.2	0.8	6.5	ns
			3.3 ± 0.3	0.6	5.0	
	t _{pLZ}		1.8	1.5	7.2	
3-state output disable		Figure 1, Figure 3	2.5 ± 0.2	0.8	3.9	ns
			3.3 ± 0.3	0.6	3.6	
	•		1.8	_	0.5	
Output to output skew	t _{osLH} t _{osHL}	(Note11)	2.5 ± 0.2	_	0.5	ns
			3.3 ± 0.3	_	0.5	

For $C_L = 50$ pF, add approximately 300 ps to the AC maximum specification.

Note11: This parameter is guaranteed by design.

 $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$

Dynamic Switching Characteristics (Ta = 25°C, Input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
			vCC (v)		
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1)	2) 1.8	0.15	
Quiet output maximum dynamic V _{OL}	V_{OLP}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1)	2) 2.5	0.25	V
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1	2) 3.3	0.35	
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1	2) 1.8	-0.15	
Quiet output minimum dynamic V _{OL}	V _{OLV}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1	2) 2.5	-0.25	V
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1	2) 3.3	-0.35	
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1	2) 1.8	1.55	
Quiet output minimum dynamic VOH	V_{OHV}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1	2) 2.5	2.05	V
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note1	2) 3.3	2.65	

Note12: This parameter is guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

Characteristics	Cumbal	Test Condition		Turn	Lloit
Characteristics	Symbol	rest Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	_	1.8, 2.5, 3.3	6	pF
Output capacitance	CO	_	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note	13) 1.8, 2.5, 3.3	20	pF

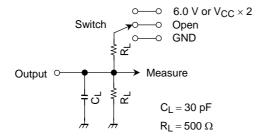
Note13: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$

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AC Test Circuit



Parameter	Switch		
t _{pLH} , t _{pHL}	Open		
t _{pLZ} , t _{pZL}	6.0 V V _{CC} × 2	$@V_{CC} = 3.3 \pm 0.3 \text{ V} \\ @V_{CC} = 2.5 \pm 0.2 \text{ V} \\ @V_{CC} = 1.8 \text{ V} \\ \\$	
t _{pHZ} , t _{pZH}	GND		

Figure 1

AC Waveform

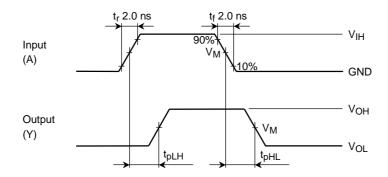


Figure 2 t_{pLH}, t_{pHL}

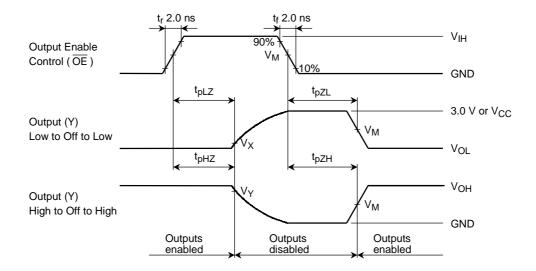
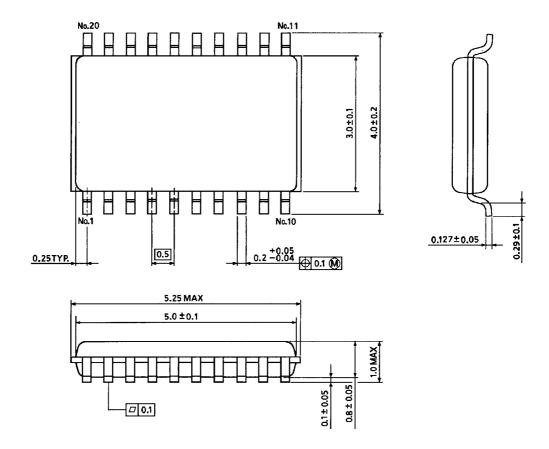


Figure 3 $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$

Cumbal		V _{CC}	
Symbol	$3.3\pm0.3~\textrm{V}$	$2.5\pm0.2\textrm{V}$	1.8 V
V _{IH}	2.7 V	V _{CC}	V _{CC}
V _M	1.5 V	V _{CC} /2	V _{CC} /2
V _X	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V
VY	V _{OH} – 0.3 V	V _{OH} – 0.15 V	V _{OH} – 0.15 V

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Package Dimensions



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Weight: 0.03 g (typ.)

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